

8-BIT PARALLEL IN/OUT DARLINGTON SOURCE DRIVER WITH LATCH

Check for Samples: [TLC59213](#), [TLC59213A](#)

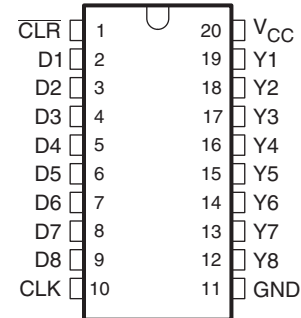
FEATURES

- Output Current on Each Channel (I_{OUT} Max = –500 mA)
- $V_{CE(sus)} = 13.2$ V
- Input Compatible With TTL/5-V CMOS
- Clear (CLR) and Clock (CLK) TTL/CMOS Control Inputs
- CLR Control Input to Off the Output
- Darlington Source Driver
- Clock Input Up to 1 MHz
- Enhanced Hold Time (t_h) on TLC59213A
- Temperature Range: –40°C to 85°C

APPLICATIONS

- Lamp and Display (LED)
- Hammer
- Relay

N OR PW PACKAGE
(TOP VIEW)



DESCRIPTION

The TLC59213 and TLC59213A are 8-bit source drivers with input latch with CLK input and $\overline{CLR}$ to set the output OFF. The TLC59213 and TLC59213A have large output source currents up to 500 mA with Darlington transistor and collectors tied to V_{CC} . These feature make the device optimum level of driving the matrix of ink jet printer head, LEDs, and the scan-side of resistor's matrix. The TLC59213 and TLC59213A differ only in the Data Hold Time Specification (t_h).

The clamp diode is between output and ground for switching inductive load.

All inputs are TTL/CMOS, which enable to any logic-level inputs such as MCU, CPU or SN74LV594 (serial to parallel) and the output enable LED matrix display. It can also be used with another device sink driver such as TLC59210, TLC59211 and TLC59212.

ORDERING INFORMATION⁽¹⁾

T_A	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Tube of 20	TLC59213IN	TLC59213IN
	TSSOP – PW	Reel of 2000	TLC59213IPWR	Y59213
	PDIP – N	Tube of 20	TLC59213AIN	TLC59213AIN
	TSSOP – PW	Reel of 2000	TLC59213AIPWR	Y59213A
		Reel of 250	TLC59213AIPWT	

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



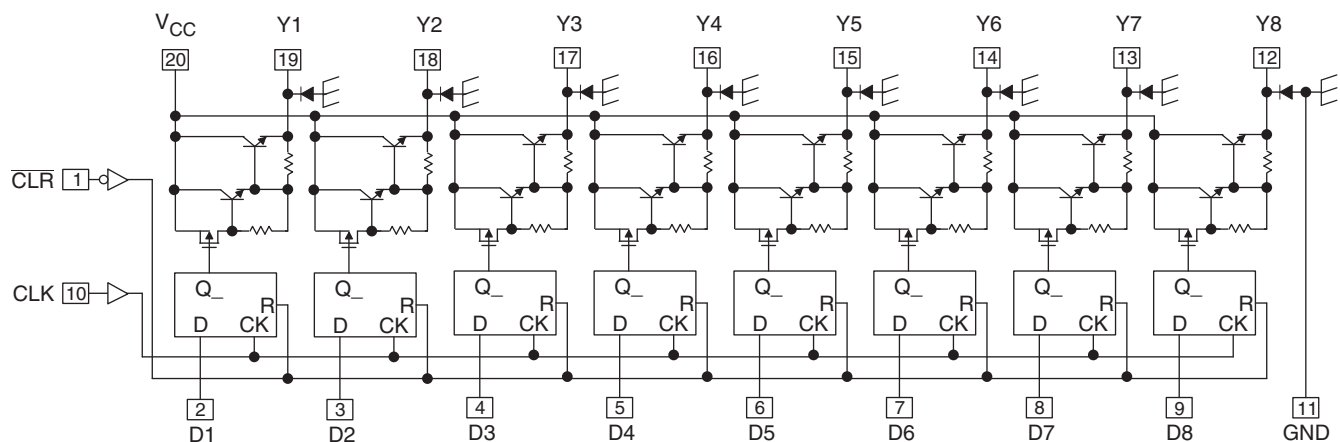
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**FUNCTION TABLE
(EACH LATCH)⁽¹⁾**

INPUTS			OUTPUT Y
CLR	CLK	D	
L	X	X	Z (OFF)
H	↑	L	Z (OFF)
H	↑	H	H (ON)
H	L	X	Y ₀
H	↓	X	Y ₀

- (1) L: Low-level
H: High-level
X: Irrelevant
↑: Rising edge
↓: Falling edge
Z: High-impedance (off)

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{DD}	Supply voltage range	-0.5	15	V
V _I	Input voltage range	-0.5	V _{CC} + 0.5	V
	Collector-emitter voltage	-0.5	15	V
I _O	Peak output current		-500	mA
I _{IK}	Input clamp current	V _I < 0 V	-20	mA
I _{OK}	Output clamp current	V _O < 0 V	-500	mA
θ _{JA}	Package thermal impedance ⁽²⁾	N package	69	°C/W
		PW package	83	
T _{stg}	Storage temperature range	-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		CONDITIONS		MIN	MAX	UNIT
V _{CC}	Supply voltage			4.5	13.2	V
V _{IH}	High-level input voltage			2		V
V _{IL}	Low-level input voltage				0.8	V
I _O	Output current (8 channel)	N package	Duty cycle < 10%	400		mA
			Duty cycle < 50%	200		
		PW package	Duty cycle < 10%	350		
			Duty cycle < 50%	170		
T _A	Operating free-air temperature			−40	85	°C

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{CEX}	Output leakage current	$V_{CC} = 13.2\text{ V}$, Outputs off			2	μA
$V_{CE(sus)}$	Output saturation voltage	$I_{OUT} = -350\text{ mA}$			2.35	V
		$I_{OUT} = -225\text{ mA}$			2.15	
		$I_{OUT} = -100\text{ mA}$			1.96	
I_I	Input current	$V_{CC} = 13.2\text{ V}$, $V_I = 0\text{ or }13.2\text{ V}$			1	μA
V_f	Clamp forward voltage	$I_f = -350\text{ mA}$	-2			V
I_{CC}	Supply current	$V_{CC} = 13.2\text{ V}$, $V_I = 0\text{ or }13.2\text{ V}$	All outputs OFF		4.6	mA
			All outputs ON		4.8	
C_I	Input capacitance				10	pF

TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted), see [Figure 3](#)

PARAMETER			TEST CONDITIONS	MIN	MAX	UNIT
t _{su}	Setup time	D before CLK ↑		50		ns
		$\overline{\text{CLR}}$ high before CLK ↑		50		ns
t _h	Hold time	D after CLK ↑	TLC59213, TLC59213A	T _A = -40°C to 85°C	50	ns
			TLC59213	T _A = 0°C to 70°C	25	
			TLC59213A	T _A = 0°C to 70°C, V _{CC} = 4.5 V to 5.5 V	15	
				T _A = 0°C to 70°C, V _{CC} = 10.8 V to 13.2 V	19	
t _w	Pulse width	CLK, $\overline{\text{CLR}}$		100		ns

SWITCHING CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted), see [Figure 3](#)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$T_A = 25^\circ\text{C}$			$T_A = -40^\circ\text{C to }85^\circ\text{C}$		UNIT
					MIN	TYP	MAX	MIN	MAX	
t_{PLH}	Propagation delay time, low-to-high level output	CLK	Y	$R_L = 25\ \Omega$, $C_L = 15\text{ pF}$		107	200		250	ns
t_{PHL}	Propagation delay time, high-to-low level output	CLK	Y	$R_L = 25\ \Omega$, $C_L = 15\text{ pF}$		111	200		250	ns
t_{PHLR}		$\overline{\text{CLR}}$	Y			104	200		250	

THERMAL INFORMATION **MAXIMUM OUTPUT CURRENT** **vs** **DUTY CYCLE**

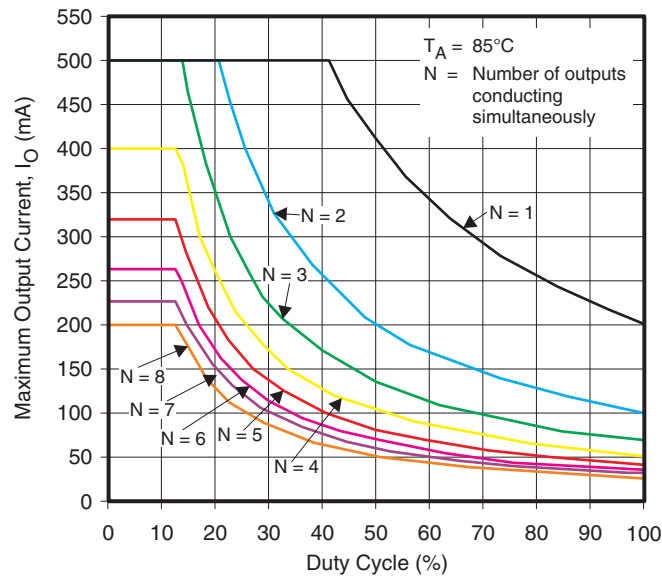


Figure 1. TSSOP (PW) PACKAGE

MAXIMUM OUTPUT CURRENT **vs** **DUTY CYCLE**

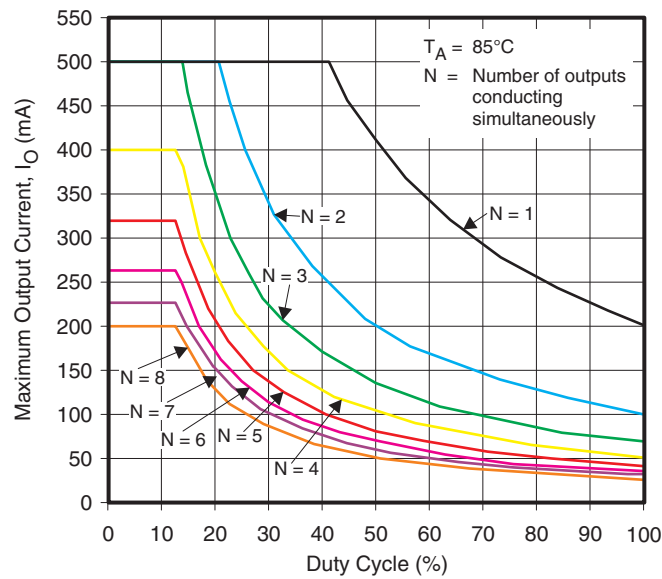
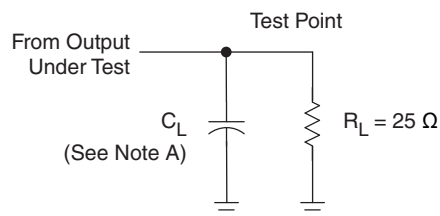
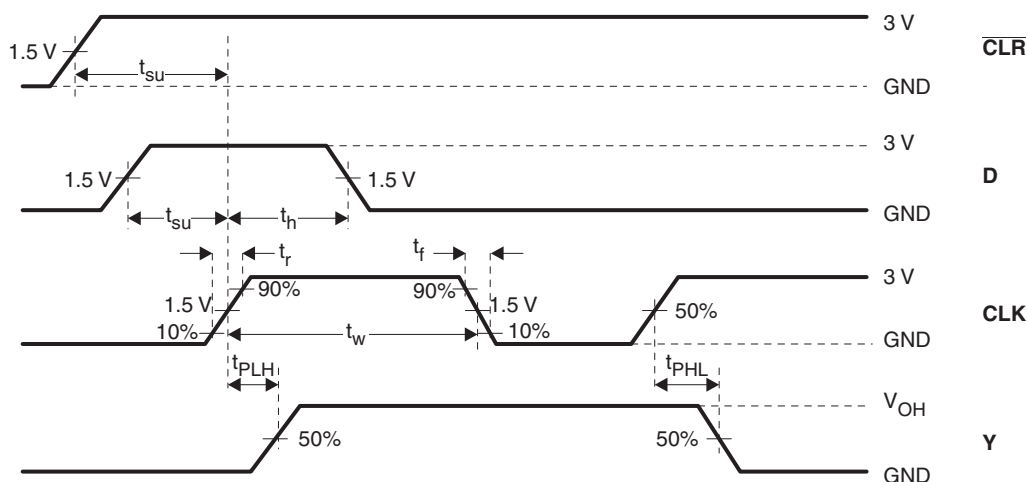


Figure 2. DIP (N) PACKAGE

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, and $t_f \leq 3\text{ ns}$.
- C. The outputs are measured one at a time with one transition per measurement.

Figure 3. Test Circuit and Voltage Waveforms

APPLICATION INFORMATION

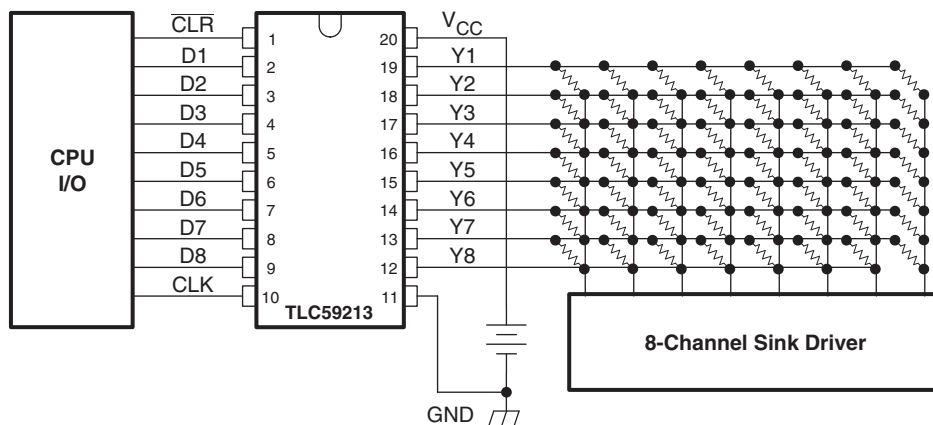


Figure 4. Example of LED Display Connection

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLC59213AIN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC59213AIPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLC59213AIPWT	PREVIEW	TSSOP	PW	20	250	TBD	Call TI	Call TI
TLC59213IN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC59213IPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC59213AIPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
TLC59213AIPWT	TSSOP	PW	20	250	180.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
TLC59213IPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

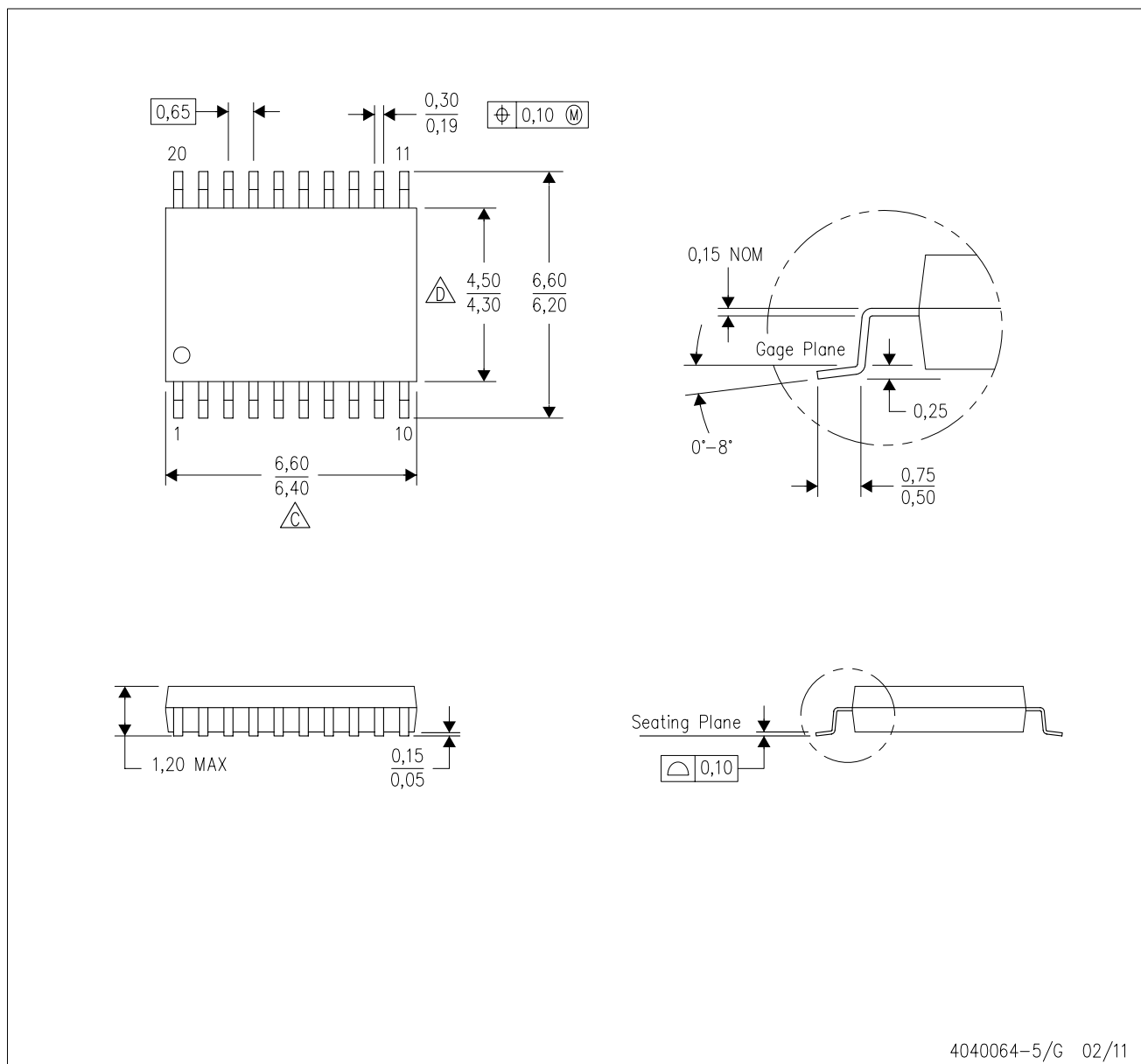


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59213AIPWR	TSSOP	PW	20	2000	346.0	346.0	33.0
TLC59213AIPWT	TSSOP	PW	20	250	190.5	212.7	31.8
TLC59213IPWR	TSSOP	PW	20	2000	346.0	346.0	33.0

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

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